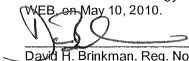



**CERTIFICATE OF ELECTRONIC
TRANSMISSION**

I hereby certify that this correspondence for
Application No. 10/555,713 is being electronically
transmitted to Technology Center 2894, via EFS-
WEB, on May 10, 2010.

David H. Brinkman, Reg. No. 40,532 Date

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Martin Hausner et al.
Serial No. : 10/555,713
Filed : October 20, 2006
Confirmation No. : 9725
Group Art Unit : 2894
Examiner : Pham, Thanh V.
Title : **RADIATION SENSOR, WAFER, SENSOR MODULE AND
METHOD FOR MANUFACTURING A RADIATION SENSOR**
Attorney Docket No. : BEET-14

Cincinnati, Ohio 45202

May 10, 2010

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

In response to the Office Action mailed on November 10, 2009, please

amend the above-identified application as follows:

Amendments to the Title begin on page 2 of this paper.

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 6 of this paper.

Amendments to the Drawings begin on page 11 of this paper.

Remarks/Arguments begin on page 12 of this paper.